



60V N-Channel Enhancement Mode MOSFET - ESD Protected

Voltage

60 V

Current

250mA

Features

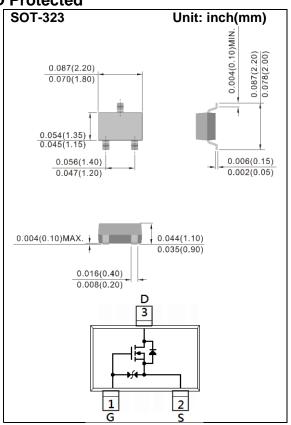
- R_{DS(ON)}, V_{GS}@10V, I_D@500mA<3Ω
- R_{DS(ON)}, V_{GS}@4.5V, I_D@200mA<4Ω
- Advanced Trench Process Technology
- High Density Cell Design For Ultra Low On-Resistance
- Very Low Leakage Current In Off Condition
- Specially Designed for Battery Operated Systems, Solid-State Relays Drivers: Relay, Displays, Memories, etc
- ESD Protected 2KV HBM
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

• Case: SOT-323 Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.0002 ounces, 0.005 grams



Maximum Ratings and Thermal Characteristics (T_A=25 °C unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNITS		
Drain-Source Voltage		V _{DS}	60	V	
Gate-Source Voltage		V_{GS}	<u>+</u> 20		
Continuous Drain Current		I _D	250	mA	
Pulsed Drain Current		I _{DM}	1000		
B Bississifier	T _a =25°C	P_{D}	350	mW	
Power Dissipation	Derate above 25°C		2.8	mW/°C	
Operating Junction and Storage Temperature Range		T_J, T_{STG}	-55~150	°C	
Typical Thermal Resistance					
- Junction to Ambient (Note 3)		$R_{\theta JA}$	357	°C/W	





Electrical Characteristics (T_A=25 °C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS	
Static							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V,I _D =10uA	60	-	-	V	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250uA$	1	-	2.5	V	
Burio Con Con Conta Buriota	Б	V _{GS} =10V,I _D =500mA	-	-	3	Ω	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =4.5V,I _D =200mA	-	-	4		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V,V _{GS} =0V	-	-	1	uA	
Gate-Source Leakage Current	I _{GSS}	V _{GS} = <u>+</u> 20V,V _{DS} =0V	-	-	<u>+</u> 10		
Forward Transconductance	g _{fs}	V _{DS} =15V, I _D =250mA	100	-	-	mS	
Dynamic (Note 5)							
Total Gate Charge	Q_g	V _{DS} =15V, I _D =250mA, V _{GS} =5V ^(Note 1,2)	-	0.8	-	nC	
Gate-Source Charge	Q_gs		-	0.35	-		
Gate-Drain Charge	Q_gd		-	0.2	-		
Input Capacitance	Ciss	V_{DS} =25V, V_{GS} =0V, f =1MHZ	-	24	-	pF	
Output Capacitance	Coss		-	13	-		
Reverse Transfer Capacitance	Crss		-	8	-		
Turn-On Delay Time	td _(on)	V_{DD} =30V, I_{D} =200mA, V_{GS} =10V, R_{G} =10 Ω (Note 1,2)	-	3	-		
Turn-On Rise Time	tr		-	19	-	ns	
Turn-Off Delay Time	td _(off)		-	15	-		
Turn-Off Fall Time	tf		-	23	-		
Drain-Source Diode							
Maximum Continuous Drain-Source					250	mA	
Diode Forward Current	I _S		-	_	200		
Diode Forward Voltage	V_{SD}	I _S =200mA, V _{GS} =0V	-	0.82	1.3	V	

NOTES:

- 1. Pulse width<a>300us, Duty cycle<a>2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Rejah is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1 inch FR-4 with 2oz. square pad of copper.
- 4. The maximum current rating is package limited.
- 5. Guaranteed by design, not subject to production testing.





TYPICAL CHARACTERISTIC CURVES

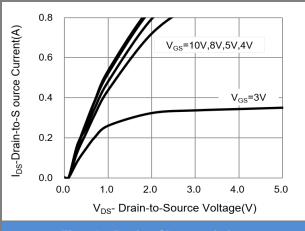


Fig.1 On-Region Characteristics

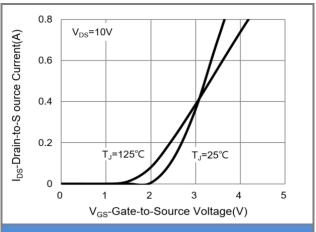


Fig.2 Transfer Characteristics

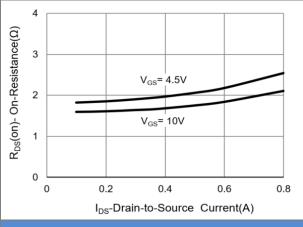


Fig.3 On-Resistance vs. Drain Current

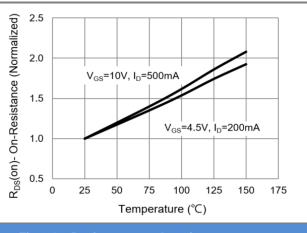


Fig.4 On-Resistance vs. Junction temperature

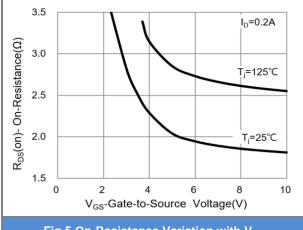


Fig.5 On-Resistance Variation with V_{GS}

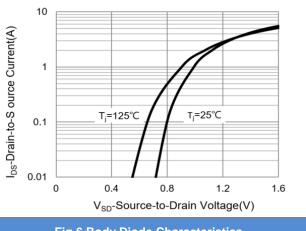


Fig.6 Body Diode Characteristics





TYPICAL CHARACTERISTIC CURVES

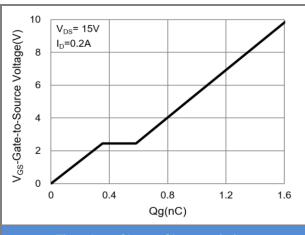


Fig.7 Gate-Charge Characteristics

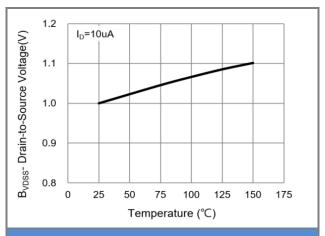


Fig.8 Breakdown Voltage Variation vs. Temperature

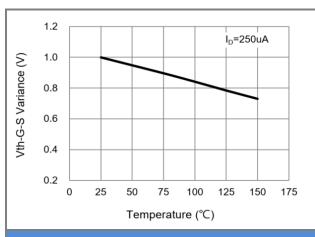


Fig.9 Threshold Voltage Variation with Temperature

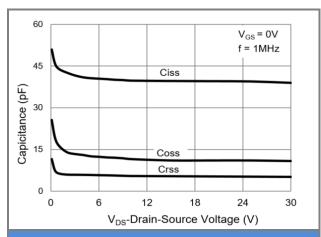


Fig.10 Capacitance vs. Drain-Source Voltage

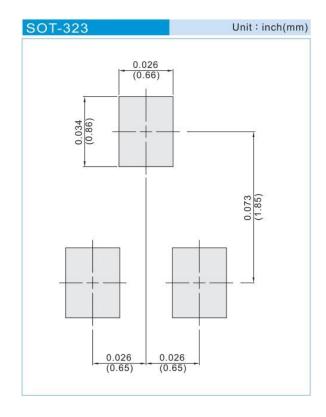




Part No Packing Code Version

Part No Packing Code	Package Type	Packing Type	Marking	Version
2N7002KW-AU_R1_000A1	SOT-323	3K pcs / 7" reel	K72	Halogen free

Mounting Pad Layout







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